MC68EC030

Technical Summary

Second-Generation 32-Bit Enhanced Embedded Controller

The MC68EC030 is a 32-bit embedded controller that streamlines the functionality of an MC68030 for the requirements of embedded control applications. The MC68EC030 is optimized to maintain performance while using cost-effective memory subsystems. The rich instruction set and addressing mode capabilities of the MC68020, MC68030, and MC68040 have been maintained, allowing a clear migration path for M68000 systems. The main features of the MC68EC030 are as follows:

- Object-Code Compatible with the MC68020, MC68030, and Earlier M68000 Microprocessors
- Burst-Mode Bus Interface for Efficient DRAM Access
- On-Chip Data Cache (256 Bytes) and On-Chip Instruction Cache (256 Byte)
- Dynamic Bus Sizing for Direct Interface to 8-, 16-, and 32-Bit Devices
- 25- and 40-MHz Operating Frequency (up to 9.2 MIPS)
- · Advanced Plastic Pin Grid Array Packaging for Through-Hole Applications

Additional features of the MC68EC030 include:

- Complete 32-Bit Nonmultiplexed Address and Data Buses
- Sixteen 32-Bit General-Purpose Data and Address Registers
- Two 32-Bit Supervisor Stack Pointers and Eight Special-Purpose Control Registers
- Two Access Control Registers Allow Blocks To Be Defined for Cacheability Protection
- · Pipelined Architecture with Increased Parallelism Allows:
 - Internal Caches Accesses in Parallel with Bus Transfers
 - Overlapped Instruction Execution
- Enhanced Bus Controller Supports Asynchronous Bus Cycles (three clocks minimum), Synchronous Bus Cycle (two clocks minimum), and Burst Data Transfers (one clock)
- Complete Support for Coprocessors with the M68000 Coprocessor Interface
- Internal Status Indication for Hardware Emulation Support
- 4-Gbyte Direct Addressing Range
- Implemented in Motorola's HCMOS Technology That Allows CMOS and HMOS (High-Density NMOS) Gates To Be Combined for Maximum Speed, Low Power, and Small Die Size

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INTRODUCTION

The MC68EC030 is an integrated controller that incorporates the capabilities of the MC68030 integer unit, a data cache, an instruction cache, an access control unit (ACU), and an improved bus controller on one VLSI device. It maintains the 32-bit registers available with the entire M68000 Family as well as the 32-bit address and data paths, rich instruction set, versatile addressing modes, and flexible coprocessor interface provided with the MC68020 and MC68030. In addition, the internal operations of this integrated controller are designed to operate in parallel, allowing instruction execution to proceed in parallel with accesses to the internal caches and the bus controller.

The MC68EC030 fully supports the nonmultiplexed asynchronous bus of the MC68020 and MC68030 as well as the dynamic bus sizing mechanism that allows the controller to transfer operands to or from external devices while automatically determining device port size on a cycle-by-cycle basis. In addition to the asynchronous bus, the MC68EC030 also supports the fast synchronous bus of the MC68030 for off-chip caches and fast memories. Like the MC68030, the MC68EC030 bus is capable of fetching up to four long words of data in a burst mode compatible with DRAM chips that have burst capability. Burst mode can reduce (up to 50 percent) the time necessary to fetch the four long words. The four long words are used to prefill the on-chip instruction and data caches so that the hit ratio of the caches is improved and the average access time for operand fetches is minimized.

The MC68EC030 is specifically designed to sustain high performance while using low-cost (DRAM) memory subsystems. Coupled with the MC88916 clock generation and distribution circuit, the MC68EC030 provides simple interface to lower speed memory subsystems. The MC88916 (see Figure 1) provides the precise clock signals required to efficiently control memory subsystems, eliminating system design constraints due to clock generation and distribution.

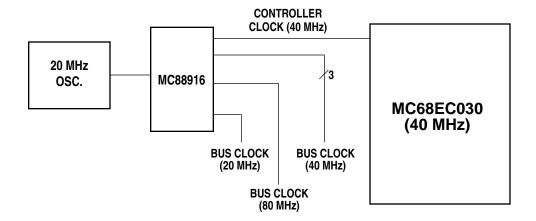


Figure 1. MC68EC030 Clock Circuitry

The block diagram shown in Figure 2 depicts the major sections of the MC68EC030 and illustrates the autonomous nature of these blocks. The bus controller consists of the address and data pads, the multiplexers required to support dynamic bus sizing, and a microbus controller that schedules the bus cycles on the basis of priority. The micromachine contains the execution unit and all related control logic. Microcode control is provided by a modified two-level store of microROM and nanoROM contained in the micromachine. Programmed logic arrays (PLAs) are used to provide instruction decode and sequencing

information. The instruction pipe and other individual control sections provide the secondary decode of instructions and generate the actual control signals that result in the decoding and interpretation of nanoROM and microROM information.

The instruction and data cache blocks operate independently from the rest of the machine, storing information read by the bus controller for future use with very fast access time. Each cache resides on its own address bus and data bus, allowing simultaneous access to both. The data and instruction caches are organized as a total of 64 long-word entries (256 bytes) with a line size of four long words. The data cache uses a write-through policy with programmable write allocation for cache misses.

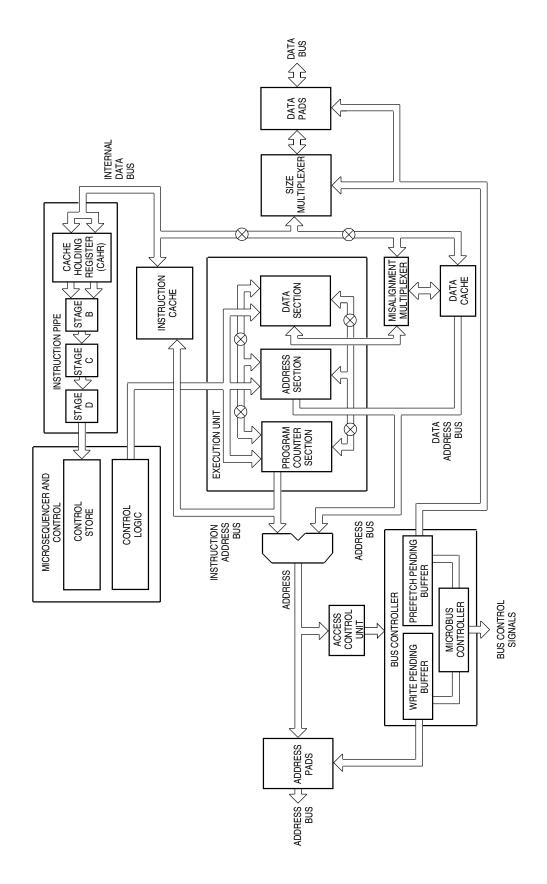


Figure 2. Block Diagram

The ACU contains two access control registers that are used to define memory segments ranging in size from 16 Mbytes to 2 Gbytes each. Each segment is definable in terms of address, read/write access, and function code. Each segment can be marked as cacheable or non cacheable to control cache accesses to that memory space.

PROGRAMMING MODEL

As shown in the programming models (see Figures 3 and 4), the MC68EC030 has 16 32-bit general-purpose registers, a 32-bit program counter, two 32-bit supervisor stack pointers, a 16-bit status register, a 32-bit vector base register, two 3-bit alternate function code registers, two 32-bit cache handling (address and control) registers, and two 32-bit transparent translation registers. Registers D0–D7 are used as data registers for bit and bit field (1 to 32 bit), byte (8 bit), word (16 bit), long-word (32 bit), and quad-word (64 bit) operations. Registers A0–A6 and the user, interrupt, and master stack pointers are address registers that may be used as software stack pointers or base address registers. In addition, the address registers may be used for word and long-word operations. All 16 general-purpose registers (D0–D7, A0–A7) can be used as index registers.

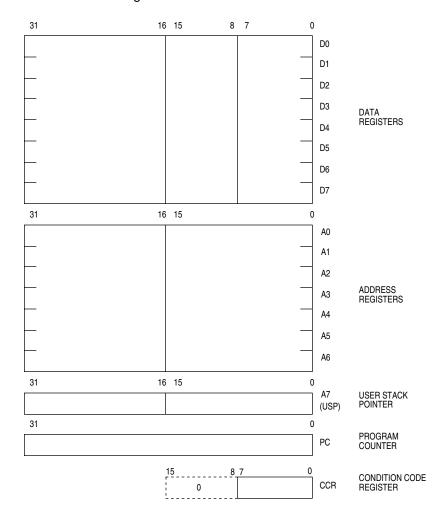


Figure 3. User Programming Model

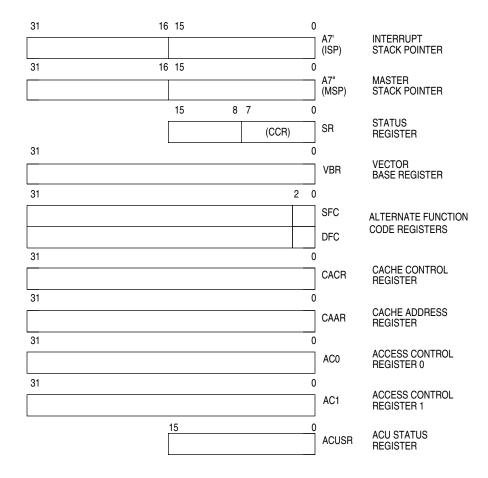


Figure 4. Supervisor Programming Model Supplement

The status register (see Figure 5) contains the interrupt priority mask (three bits) as well as the following condition codes: extend (X), negate (N), zero (Z), overflow (V), and carry (C). Additional control bits indicate that the controller is in the trace mode (T1 or T0), supervisor/user state (S), and master/interrupt state (M).

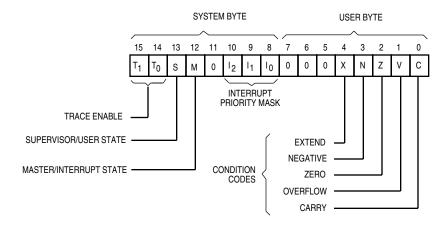


Figure 5. Status Register

All microprocessors of the M68000 Family support instruction tracing (via the T0 status bit in the MC68EC030) where each instruction executed is followed by a trap to a user-defined trace routine. The MC68EC030, like the MC68030 and MC68040, also has the capability to trace only on change-of-flow instructions (branch, jump, subroutine call and return, etc.) using the T1 status bit. These features are important for software program development and debug.

The vector base register (VBR) is used to determine the run-time location of the exception vector table in memory; thus, each separate vector table for each process or task can properly manage exceptions independent of each other.

The M68000 Family processors distinguish address spaces as supervisor/user, program/data, and CPU space. These five combinations are specified by the function code pins (FC0/FC1/FC2) during bus cycles, indicating the particular address space. Using the function codes, the memory subsystem (hardware) can distinguish between supervisor accesses and user accesses as well as program accesses, data accesses, and CPU space accesses. To support the full privileges of the supervisor, the alternate function code registers allow the supervisor to specify the function code for an access by appropriately preloading the SFC/DFC registers.

The cache registers allow supervisor software manipulation of the on-chip instruction and data caches. Control and status accesses to the caches are provided by the cache control register (CACR); the cache address register (CAAR) specifies the address for those cache control functions that require an address.

The access control registers are accessible by the supervisor only. The access control registers are used to define two memory spaces with caching restrictions. The ACU status register (ACUSR) is used to show the result of PTEST operations on the ACU.

DATA TYPES AND ADDRESSING MODES

Seven basic data types are supported by the MC68EC030:

- Bits
- Bit Fields (String of consecutive bits, 1–32 bits long)
- BCD Digits (Packed: 2 digits/byte, Unpacked: 1 digit/byte)
- Byte Integers (8 bits)
- Word Integers (16 bits)
- Long-Word Integers (32 bits)
- Quad-Word Integers (64 bits)

In addition, operations on other data types, such as memory addresses, status word data, etc., are provided in the instruction set. The coprocessor mechanism allows direct support of floating-point data types with the MC68881/MC68882 floating-point coprocessors as well as specialized user-defined data types and functions. The 18 addressing modes, listed in Table 1, include nine basic types:

- Register Direct
- Register Indirect
- Register Indirect with Index
- Memory Indirect
- Program Counter Indirect with Displacement
- Program Counter Indirect with Index
- Program Counter Memory Indirect
- Absolute
- Immediate

The register indirect addressing modes support postincrement, predecrement, offset, and indexing. These capabilities are particularly useful for handling advanced data structures common to sophisticated applications and high-level languages. The program counter relative mode also has index and offset capabilities; this addressing mode is generally required to support position- independent software. In addition to these addressing modes, the MC68EC030 provides data operand sizing and scaling; these features provide performance enhancements to the programmer.

Table 1. MC68EC030 Addressing Modes

Addressing Modes	Syntax
Register Direct Addressing Data Register Direct Address Register Direct	Dn An
Register Indirect Address Register Indirect Address Register Indirect with Postincrement Address Register Indirect with Predecrement Address Register Indirect with Displacement	(An) (An);pl -(An) (d ₁₆ ,An)
Register Indirect with Index Address Register Indirect with Index (8-Bit Displacement) Address Register Indirect with Index (Base Displacement)	(dg,An,Xn) (bd,An,Xn)
Memory Indirect Memory Indirect Postindexed Memory Indirect Preindexed	([bd,An],Xn,od) ([bd,An,Xn],od)
Program Counter Indirect with Displacement	(d ₁₆ ,PC)
Program Counter Indirect with Index PC Indirect with Index (8-Bit Displacement) PC Indirect with Index (Base Displacement)	(dg,PC,Xn) (bd,PC,Xn)
Program Counter Memory Indirect PC Memory Indirect Postindexed PC Memory Indirect Preindexed	([bd,PC],Xn,od) ([bd,PC,Xn],od)
Absolute Data Addressing Absolute Short Absolute Long	xxx.W xxx.L
Immediate	# <data></data>

NOTES:

Xn

Dn = Data Register, D0-D7 An = Address Register, A0-A7

d₈, d₁₆ = A twos-complement or sign-extended displacement; added as part of the effective address calculation; size is 8 (d₈) or 16 (d₁₆) bits; when omitted, assemblers use a value of zero.

 Address or data register used as an index register; form is Xn.SIZE*SCALE, where SIZE is .W or .L (indicates index register size) and SCALE is 1, 2, 4, or 8 (index register is multiplied by

SCÁLE); use of SIZE and/or SCÁLE is optional.

bd = A twos-complement base displacement; when present, size can be 16 or 32 bits.

od = Outer displacement added as part of effective address calculation after any memory indirection; use is optional with a size of 16 or 32 bits.

PC = Program Counter

<data> = Immediate value of 8, 16, or 32 bits

() = Effective Address

[] = Used as indirect address to long-word address.

INSTRUCTION SET OVERVIEW

The MC68EC030 instruction set is listed in Table 2. Each instruction, with few exceptions, operates on bytes, words, and long words, and most instructions can use any of the 18 addressing modes. The MC68EC030 is upward source- and object-level code compatible with the M68000 Family because it supports all instructions of previous family members.

Table 2. Instruction Set

Mnemonic	Description
ABCD	Add Decimal with Extend
ADD	Add
ADDA	Add Address
ADDI	Add Immediate
ADDQ	Add Quick
ADDX	Add with Extend
AND	Logical AND
ANDI	Logical AND Immediate
ASL,ASR	Arithmetic Shift Left and Right
BCC	Branch Conditionally
BCHG	Test Bit and Change
BCLR	Test Bit and Clear
BFCHG BFCLR	Test Bit Field and Change Test Bit Field and Clear
BFEXTS	Signed Bit Field Extract
BEFXTU	Unsigned Bit Field Extract
BFFFO	Bit Field Find First One
BFINS	Bit Field Insert
BFSET	Test Bit Field and Set
BFTST	Test Bit Field
BKPT	Breakpoint
BRA	Branch
BSET	Test Bit and Set
BSR	Branch to Subroutine
BTST	Test Bit
CAS	Compare and Swap Operands
CAS2	Compare and Swap Dual Operands
CHK	Check Register Against Bound
CHK2	Check Register Against Upper and Lower
OL D	Bounds
CLR	Clear
CMP	Compare
CMPA	Compare Address
CMPI CMPM	Compare Immediate
CMP2	Compare Memory to Memory Compare Register Against Upper and
OIVII Z	Lower Bounds
DBcc	Test Condition, Decrement and Branch
DIVS,DIVSL	Signed Divide
DIVU, DIVUL	Unsigned Divide
EOR	Logical Exclusive OR
EORI	Logical Exclusive OR Immediate
EXG	Exchange Registers
EXT, EXTB	Sign Extend
ILLEGAL	Take Illegal Instruction Trap
JMP	Jump
JSR	Jump to Subroutine
LEA	Load Effective Address
LINK	Link and Allocate
LSL, LSR	Logical Shift Left and Right
LOL, LOIX	Logical Office Lott and Might

MOVE MOVEA MOVE CCR MOVE CCR MOVE CCR MOVE SR MOVE USP MOVE USP MOVE USP MOVE USP MOVE COndition Code Register MOVEC MOVEC Move Control Register MOVEM Move Multiple Registers MOVEP MOVEQ Move Quick MOVES MOVES MOVE Alternate Address Space MULS Signed Multiply MULU Unsigned Multiply MULU Unsigned Multiply NBCD Negate Decimal with Extend NEG Negate NEGX Negate with Extend NOP NO Operation NOT Logical Inclusive OR ORI Logical Inclusive OR Immediate PACK Pack BCD PEA PUSH Effective Address PFLUSH PLOAD No Effect PLOAD No Effect PLOAD No Effect PLOAD ROXE ROXL, ROXR ROXL ROXE RETE RETE RETE RETE RETE RETE RETE RE	Mnemonic	Description
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UNLK Unlink		·
UNPK Unpack BCD		_
	UNPK	ипраск вси

Coprocessor Instructions

cpBCC	Branch Conditionally		cpRESTORE	Restore Internal State of Coprocessor
cpDBcc	Test Coprocessor Condition,	on, cpSAVE Save Internal State of Coprocessor		Save Internal State of Coprocessor
	Decrement and Branch		cpScc	Set Conditionally
cpGEN	Coprocessor General Instruction		cpTRAPcc	Trap Conditionally

Included in the MC68EC030 set are the bit field operations, binary-coded decimal support, bounds checking, additional trap conditions, and additional multiprocessing support (CAS and CAS2 instructions) offered by the MC68020, MC68030, and MC68040. In addition, object code written for the MC68EC030 can be used on the MC68040 for even more performance. The memory management unit (MMU) instructions of the MC68030, and MC68040 are not supported by the MC68EC030.

INSTRUCTION AND DATA CACHES

Studies have shown that typical programs spend most of their execution time in a few main routines or tight loops. This phenomenon, known as locality of reference, has an impact on program performance. The MC68010 takes limited advantage of this phenomenon with the loop mode of operation that can be used with the DBcc instruction. The MC68EC030 takes further advantage of cache technology to provide the system with two on-chip caches, one for instructions and one for data.

MC68EC030 CACHE GOALS

Similar to the MC68020 and MC68030, there were two primary design goals for the MC68EC030 embedded controller caches. The first design goal was to reduce the external bus activity of the CPU even more than was accomplished with the MC68020. The second design goal was to increase effective CPU throughput as larger memory sizes or slower memories increased average access time. By placing a high-speed cache between the controller and the rest of the memory system, the effective memory access time becomes:

where t_{acc} is the effective system access time, t_{cache} is the cache access time, t_{ext} is the access time of the rest of the system, and R_h is the hit ratio or the percentage of time that the data is found in the cache. Thus, for a given system design, the two MC68EC030 on-chip caches provide an even more substantial CPU performance increase over that obtainable with the MC68020 instruction cache. Alternately, slower and less expensive memories can be used for the same controller performance.

The throughput increase in the MC68EC030 is gained in three ways. First, the MC68EC030 caches are accessed in less time than is required for external accesses, providing improvement in the access time for items residing in the cache. Second, the burst filling of the caches allows instruction and data words to be found in the on-chip caches the first time they are accessed by the micromachine, minimizing the time required to bring those items into the cache. Utilizing burst fill capabilities lowers the average access time for items found in the caches even further. Third, the autonomous nature of the caches allows instruction stream fetches, data fetches, and external bus activity to occur simultaneously with instruction execution. The parallelism designed into the MC68EC030 also allows multiple instructions to execute concurrently so that several internal instructions (those that do not require any external accesses) can execute while the controller is performing an external access for a previous instruction.

INSTRUCTION CACHE

The MC68EC030 instruction cache is a 256-byte direct-mapped cache organized as 16 lines consisting of four long words per line. Each long word is independently accessible, yielding 64 possible entries, with address bit A1 selecting the correct word during an access. Thus, each line has a tag field composed of the upper 24 address bits, the FC2 (supervisor/user) value, four valid bits (one for each long-word entry), and the four long-word entries (see Figure 6). The instruction cache is automatically filled by the MC68EC030 whenever a cache miss occurs; using the burst transfer capability, up to four long words can be filled in one burst operation. The caches cannot be manipulated directly by the programmer except by the use of the CACR, which provides cache clearing and cache entry clearing facilities. The caches can also be enabled/disabled by this register. Finally, the system hardware can disable the on-chip caches at any time by asserting the CDIS signal.

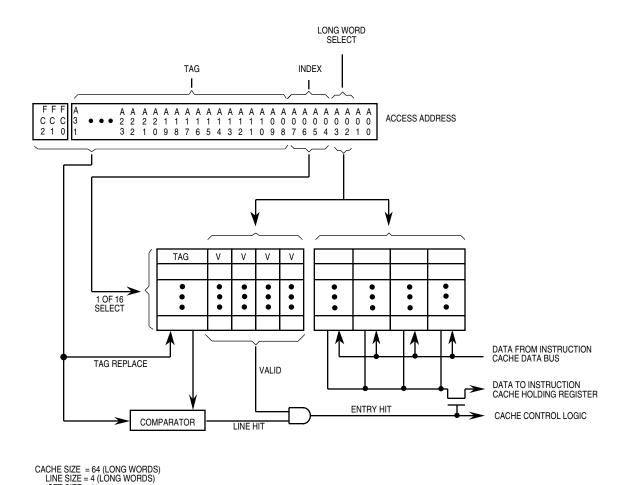


Figure 6. On-Chip Instruction Cache Organization

DATA CACHE

The organization of the data cache (see Figure 7) is similar to that of the instruction cache. However, the tag is composed of the upper 24 address bits, the four valid bits, and all three function code bits, explicitly specifying the address space associated with each line. The data cache employs a write-through policy with programmable write allocation of data writes—i.e., if a cache hit occurs on a write cycle, both the data cache and the external device are updated with the new data. If a write cycle generates a cache miss, the external device is updated, and a new data cache entry can be replaced or allocated for that address, depending on the state of the write-allocate (WA) bit in the CACR.

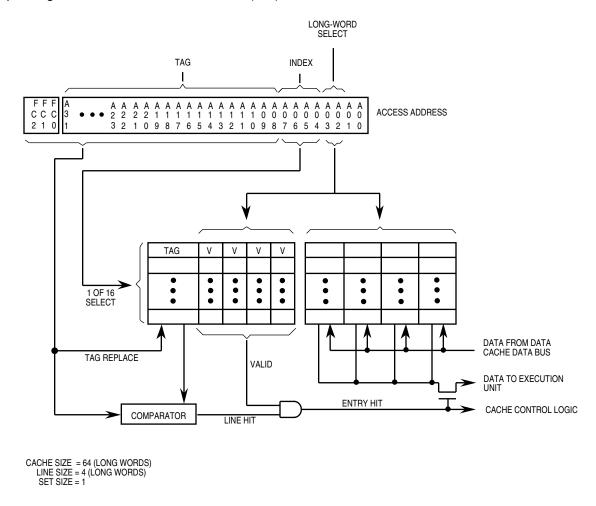


Figure 7. On-Chip Data Cache Organization

OPERAND TRANSFER MECHANISM

The MC68EC030 offers three different mechanisms by which data can be transferred into and out of the chip. Asynchronous bus cycles, compatible with the asynchronous bus on the MC68020 and MC68030, can transfer data in a minimum of three clock cycles; the amount of data transferred on each cycle is determined by the dynamic bus sizing mechanism on a cycle-by-cycle basis with the data transfer and size acknowledge (DSACKx) signals. Synchronous bus cycles, compatible with the synchronous bus on the MC68030, are terminated with the synchronous termination (STERM) signal and always transfer 32-bits of data in a minimum of two clock cycles, increasing the bus bandwidth available for other bus masters,

thereby increasing possible performance. Burst mode transfers can be used to fill lines of the instruction and data caches when the MC68EC030 asserts cache burst request (CBREQ). After completing the first cycle with STERM, subsequent cycles may accept data on every clock cycle where STERM is asserted until the burst is completed. Use of this mode can further increase the available bus bandwidth in systems that use DRAMs with page, nibble, or static-column mode operation.

ASYNCHRONOUS TRANSFERS

Though the MC68EC030 has a full 32-bit data bus, it offers the ability to automatically and dynamically downsize its bus to 8 or 16 bits if peripheral devices are unable to accommodate the entire 32 bits. This feature allows the programmer to write code that is not bus-width specific. For example, long-word (32 bit) accesses to peripherals may be used in the code; yet, the MC68EC030 will transfer only the amount of data that the peripheral can manage. This feature allows the peripheral to define its port size as 8, 16, or 32 bits wide, and the MC68EC030 will dynamically size the data transfer accordingly, using multiple bus cycles when necessary. Hence, programmers are not required to program for each device port size or know the specific port size before coding; hardware designers have the flexibility to choose hardware implementations regardless of software implementations.

The dynamic bus sizing mechanism is invoked by DSACKx and occurs on a cycle-by-cycle basis. For example, if the controller is executing an instruction that requires reading a long-word operand, it will attempt to read 32 bits during the first bus cycle to a long-word address boundary. If the port responds that it is 32 bits wide, the MC68EC030 latches all 32 bits of data and continues. If the port responds that it is 16 bits wide, the MC68EC030 latches the 16 valid bits of data and continues. An 8-bit port is handled similarly but has four bus read cycles. Each port is fixed in the assignment to particular sections of the data bus. However, the MC68EC030 has no restrictions concerning the alignment of operands in memory; long-word operands need not be aligned to long-word address boundaries. When misaligned data requires multiple bus cycles, the MC68EC030 automatically runs the minimum number of bus cycles. Instructions must still be aligned to word boundaries.

The timing of asynchronous bus cycles is also determined by the assertion of DSACKx on a cycle-by-cycle basis. If the DSACKx signals are valid 1.5 clocks after the beginning of the bus cycle (with the appropriate setup time), the cycle terminates in the minimum amount of time (corresponding to three-clock-cycle total). The cycle can be lengthened by delaying DSACKx (effectively inserting wait states in one-clock increments) until the device being accessed is able to terminate the cycle. This flexibility gives the controller the ability to communicate with devices of varying speeds while operating at the fastest rate possible for each device.

The asynchronous transfer mechanism allows external errors to abort cycles upon the assertion of bus error (BERR) or allows individual bus cycles to be retried with the simultaneous assertion of BERR and HALT.

SYNCHRONOUS TRANSFERS

Synchronous bus cycles are terminated by asserting STERM, which automatically indicates that the bus transfer is for 32 bits. Since this input is not synchronized internally, two-clock-cycle bus accesses can be performed if the signal is valid one clock after the beginning of the bus cycle with the appropriate setup time. However, the bus cycle may be lengthened by delaying STERM (inserting wait states in one-clock increments) until the device being accessed is able to terminate the cycle. After the assertion of STERM, these cycles may be aborted upon the assertion of BERR, or they may be retried with the simultaneous assertion of BERR and HALT.

BURST READ CYCLES

The MC68EC030 provides support for burst filling of its on-chip instruction and data caches, adding to the overall system performance. The on-chip caches are organized with a line size of four long words; there is only one tag for the four long words in a line. Since locality of reference is present to some degree in most programs, filling of all four entries when a single entry misses can be advantageous, especially if the time spent filling the additional entries is minimal. When the caches are burst filled, data can be latched by the controller in as little as one clock for each 32 bits. Burst read cycles can be performed only when the MC68EC030 requests them (with the assertion of CBREQ) and only when the first cycle is a synchronous cycle as previously described. If the cache burst acknowledge (CBACK) input is valid at the appropriate time in the synchronous bus cycle, the controller keeps the original AS, DS, R/W, address, function code, and size outputs asserted and latches 32 bits from the data bus at the end of each subsequent clock cycle that has STERM asserted. This procedure continues until the burst is complete (the entire block has been transferred), BERR is asserted in lieu of or after STERM, the cache inhibit in (CIIN) input is asserted, or the CBACK input is negated. The cache preloading allowed by the bursting enables the MC68EC030 to take advantage of cost-effective DRAM technology with minimal performance impact.

EXCEPTIONS

The types of exceptions and the exception processing sequence are discussed in the following paragraphs.

TYPES OF EXCEPTIONS

Exceptions can be generated by either internal or external causes. The externally generated exceptions are interrupts, BERR, and RESET. Interrupts are requests from peripheral devices for controller action; whereas, BERR and RESET are used for access control and controller restart. The internally generated exceptions come from instructions, address errors, tracing, or breakpoints. The TRAP, TRAPcc, TRAPvcc, cpTRAPcc, CKH, CKH2, and DIV instructions can all generate exceptions as part of instruction execution. Tracing behaves like a very high-priority, internally generated interrupt whenever it is processed. The other internally generated exceptions are caused by illegal instructions, instruction fetches from odd addresses, and privilege violations.

EXCEPTION PROCESSING SEQUENCE

Exception processing occurs in four steps. During the first step, an internal copy is made of the status register. After the copy is made, the special controller state bits in the status register are changed. The S-bit is set, putting the controller into the supervisor state. Also, the T1 and T0 bits are negated, allowing the exception handler to execute unhindered by tracing. For the reset and interrupt exceptions, the interrupt priority mask is also updated.

In the second step, the vector number of the exception is determined. For interrupts, the vector number is obtained by a controller read that is classified as an interrupt acknowledge cycle. For coprocessor-detected exceptions, the vector number is included in the coprocessor exception primitive response. For all other exceptions, internal logic provides the vector number. This vector number is then used to generate the address of the exception vector.

The third step is to save the current controller status. The exception stack frame is created and filled on the current supervisor stack. To minimize the amount of machine state that is saved, various stack frame sizes are used to contain the controller state, depending on the type of exception and where it occurred during instruction execution. If the exception is an interrupt and the M-bit is set, the M-bit is then cleared, and the short four-word exception stack frame that is saved on the master stack is also saved on the interrupt stack. If the exception is a reset, the M-bit is simply cleared, and the reset vector is accessed.

The MC68EC030 provides the same extensions to the exception stacking process as the MC68020, MC68030, and MC68040. If the M-bit is set, the master stack pointer (MSP) is used for all task-related exceptions. When a nontask-related exception occurs (i.e., an interrupt), the M bit is cleared, and the interrupt stack pointer (ISP) is used. This feature allows all the task's stack area to be carried within a single controller control block, and new tasks can be initiated by simply reloading the MSP and setting the M-bit.

The fourth and last step of exception processing is the same for all exceptions. The exception vector offset is determined by multiplying the vector number by four. This offset is then added to the contents of the vector base register (VBR) to determine the memory address of the exception vector. The new program counter is fetched from the exception vector. The instruction at the address given in the exception vector is fetched, and normal instruction decoding and execution is started.

STATUS and REFILL

The MC68EC030 provides the STATUS and REFILL signals to identify internal microsequencer activity associated with the processing of data pipelined in the pipeline. Since bus cycles are independently controlled and scheduled by the bus controller, information concerning the processing state of the microsequencer is not available by monitoring bus signals by themselves. The internal activity identified by the STATUS and REFILL signals include instruction boundaries, some exception conditions, when the microsequencer has halted, and instruction pipeline refills. STATUS and REFILL track only the internal microsequencer activity and are not directly related to bus activity.

ACCESS CONTROL

Two access control registers are provided on the MC68EC030 to control cachability of accesses for two independent blocks of memory. Each block can range in size from 16 Mbytes to 2 Gbytes, and is specified in the corresponding ACx register with a base address, a base mask, function code, function code mask, and read/write mask. A typical use for an access control register is to designate a block of memory containing I/O devices as non-cachable.

COPROCESSOR INTERFACE

The coprocessor interface is a mechanism for extending the instruction set of the M68000 Family. The interface provided on the MC68EC030 is the same as that on the MC68020 and MC68030. Examples of these extensions are the addition of specialized data operands for the existing data types or, for the case of floating point, the inclusion of new data types and operations implemented by the MC68881/MC68882 floating-point coprocessors.

SIGNAL DESCRIPTION

Figure 8 illustrates the functional signal groups, and Table 3 describe the signals and their function.

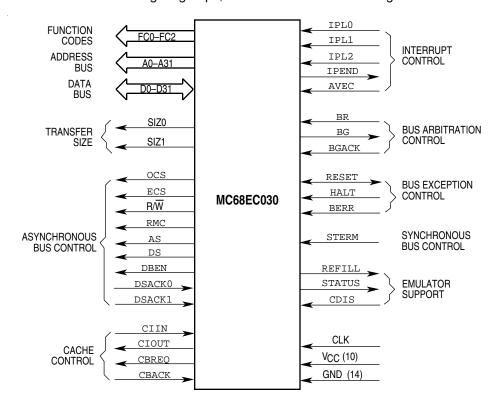


Figure 8. Functional Signal Groups

Table 3. Signal Index

Signal Name	Mnemonic	Function
Function Codes	FC0-FC2	3-bit function code used to identify the address space of each bus cycle.
Address Bus	A0-A31	32-bit address bus.
Data Bus	D0-D31	32-bit data bus used to transfer 8, 16, 24, or 32 bits of data per bus cycle.
Size	SIZ0-SIZ1	Indicates the number of bytes remaining to be transferred for this cycle. These signals, together with A0 and A1, define the active sections of the data bus.
Operand Cycle Start	OCS	Identical operation to that of ECS except that OCS is asserted only during the first bus cycle of an operand transfer
External Cycle Start	ECS	Provides an indication that a bus cycle is beginning.
Read/Write	R/W	Defines the bus transfer as a controller read or write.
Read-Modify-Write Cycle	RMC	Provides an indicator that the current bus cycle is part of an indivisible read-modify-write operation.
Address Strobe	AS	Indicates that a valid address is on the bus.
Data Strobe	DS	Indicates that valid data is to be placed on the data bus by an external device or has been replaced by the MC68EC030.
Data Buffer Enable	DBEN	Provides an enable signal for external data buffers.
Data Transfer and Size Acknowledge	DSACK0, DSACK1	Bus response signals that indicate the requested data transfer operation has completed. In addition, these two lines indicate the size of the external bus port on a cycle-by-cycle basis and are used for asynchronous transfers.
Synchronous Termination	STERM	Bus response signal that indicates a port size of 32 bits and that data may be latched on the next falling clock edge.
Cache Inhibit In	CIIN	Prevents data from being loaded into the MC68EC030 instruction and data caches.
Cache Inhibit Out	CIOUT	Reflects the CI bit in ACx registers; indicates that external caches should ignore these accesses.
Cache Burst Request	CBREQ	Indicates a burst request for the instruction or data cache.
Cache Burst Acknowledge	CBACK	Indicates that the accessed device can operate in burst mode.
Interrupt Priority Level	IPL0-IPL2	Provides an encoded interrupt level to the controller.
Interrupt Pending	IPEND	Indicates that an interrupt is pending.
Autovector	AVEC	Requests an autovector during an interrupt acknowledge cycle.
Bus Request	BR	Indicates that an external device requires bus mastership.
Bus Grant	BG	Indicates that an external device may assume bus mastership.
Bus Grant Acknowledge	BGACK	Indicates that an external device has assumed bus mastership.
Reset	RESET	System reset.
Halt	HALT	Indicates that the controller should suspended bus activity.
Bus Error	BERR	Indicates that an erroneous bus operation is being attempted.
Cache Disable	CDIS	Dynamically disables the on-chip cache to assist emulator support.
Pipe Refill	REFILL	Indicates when the MC68EC030 is beginning to fill pipeline.
Microsequencer Status	STATUS	Indicates the state of the microsequencer.

Clock	CLK	Clock input to the controller.
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Table 3. Signal Index - Continued

Signal Name	Mnemonic	Function
Power Supply	VCC	Power supply.
Ground	GND	Ground connection.
No Connect	NC	Do not connect.

ELECTRICAL SPECIFICATIONS

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	VCC	-0.3 to +7.0	V
Input Voltage	V _{in}	-0.5 to +7.0	V
Operating Temperature Range Minimum Ambient Temperature Maximum Ambient Temperature	T _A T _A	0 70	ပွ
Storage Temperature Range	T _{stg}	-55 to 150	∞

The device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, normal precautions should be taken to avoid application of voltages higher than maximum-rated voltages to these high-impedance circuits. Tying unused inputs to the appropriate logic voltage level (e.g., either GND or VCC) enhances reliability of operation.

THERMAL CHARACTERISTICS-- PGA PACKAGE

Characteristic	Symbol	Value	Rating
Thermal Resistance - Plastic Junction to Ambient Junction to case	θ_{JA}	32 TBD	°C/W

POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from:

$$T_{J}=T_{A}+(P_{D} \bullet \theta_{JA}) \tag{1}$$

where:

T_A = Ambient Temperature, °C

θJ_A = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD = PINT + PI/O

PINT = ICC X VCC, Watts — Chip Internal Power

PI/O = Power Dissipation on Input and Output Pins — User Determined

For most applications, PI/O<PINT and can be neglected.

The following is an approximate relationship between PD and TJ (if PI/O is neglected):

$$P_D=K \div (T_J+273^{\circ}C) \tag{2}$$

Solving Equations (1) and (2) for K gives:

$$K=P_{D} \bullet (T_{A} + 273^{\circ}C) + \theta_{JA} \bullet P_{D}^{2}$$
(3)

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring P_D (at thermal equilibrium) for a known T_A. Using this value of K, the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A.

The total thermal resistance of a package (θ JA) can be separated into two components, θ JC and θ CA, representing the barrier to heat flow from the semiconductor junction to the package (case) surface (θ JC) and from the case to the outside ambient air (θ CA). These terms are related by the equation:

$$\theta_{JA} = \theta_{JC} + \theta_{CA}$$
 (4)

 θ_{JC} is device related and cannot be influenced by the user. However, θ_{CA} is user dependent and can be minimized by such thermal management techniques as heat sinks, ambient air cooling, and thermal convection. Thus, good thermal management on the part of the user can significantly reduce θ_{CA} so that θ_{JA} approximately equals; θ_{JC} . Substitution of θ_{JC} for θ_{JA} in equation (1) results in a lower semiconductor junction temperature.

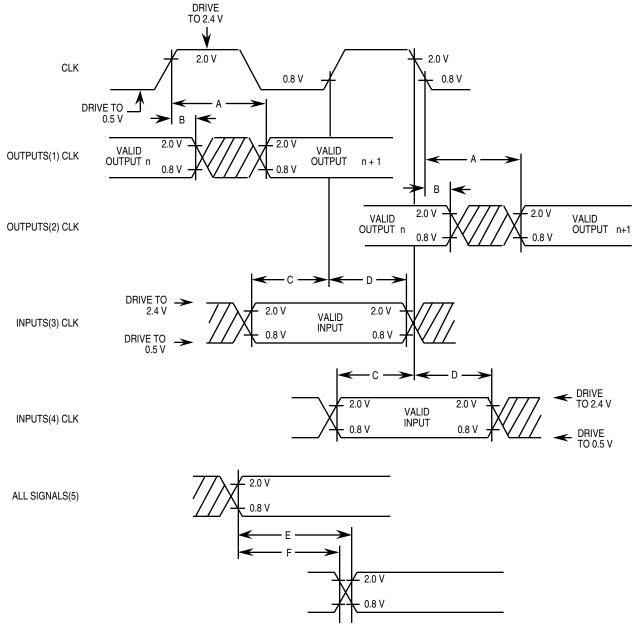
Values for thermal resistance presented in this document, unless estimated, were derived using the procedure described in Motorola Reliability Report 7843, "Thermal Resistance Measurement Method for MC68XX Microcomponent Devices," and are provided for design purposes only. Thermal measurements are complex and dependent on procedure and setup. User derived values for thermal resistance may differ.

AC ELECTRICAL SPECIFICATION DEFINITIONS

The AC specifications presented consist of output delays, input setup and hold times, and signal skew times. All signals are specified relative to an appropriate edge of the clock and possibly to one or more other signals.

The measurement of the AC specifications is defined by the waveforms shown in Figure 9. To test the parameters guaranteed by Motorola, inputs must be driven to the voltage levels specified in Figure 9. Outputs are specified with minimum and/or maximum limits, as appropriate, and are measured as shown in Figure 9. Inputs are specified with minimum setup and hold times, and are measured as shown. Finally, the measurement for signal-to-signal specifications is also shown.

Note that the testing levels used to verify conformance to the AC specifications does not affect the guaranteed DC operation of the device as specified in the DC electrical specifications.



NOTES:

- 1. This output timing is applicable to all parameters specified relative to the rising edge of the clock.
- 2. This output timing is applicable to all parameters specified relative to the falling edge of the clock.
- 3. This input timing is applicable to all parameters specified relative to the rising edge of the clock.
- 4. This input timing is applicable to all parameters specified relative to the falling edge of the clock.5. This timing is applicable to all parameters specified relative to the assertion/negation of another signal.
- o. This timing is applicable to all parameters specified relative to the assertion meganion of another

LEGEND:

- A. Maximum output delay specification.
- B. Minimum output hold time.
- C. Minimum input setup time specification.
- D. Minimum input hold time specification.
- E. Signal valid to signal valid specification (maximum or minimum).
- F. Signal valid to signal invalid specification (maximum or minimum).

Figure 9. Drive Levels and Test Points for AC Specifications

DC ELECTRICAL SPECIFICATIONS

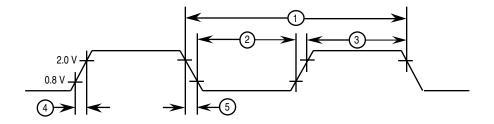
(VCC=5.0 Vdc \pm 5%; GND=0Vdc; temperature in defined ranges)

С	haracteristics	Symbol	Min	Max	Unit
Input High Voltage		VIH	2.0	Vcc	V
Input Low Voltage		V _{IL}	GND -0.5	0.8	V
Input Leakage Current GND≤V _{in} ,≤V _{CC}	BERR,BR, BGACK, CLK,.IPL0–IPL2, AVEC, CDIS, DSACK0, DSACK1 HALT, RESET	l _{in}	-2.5 -20	2.5 20	μΑ
Hi-Z (Off-State) Leakage Current @ 2.4 V/0.5 V	A0-A31, AS, DBEN, DS, D0-D31, FC0-FC2, R/W, RMC, SIZ0-SIZ1	^I TSI	-20	20	μΑ
Output High Voltage IOH = 400 μA	A0–A31, AS, BG, D0–D31, DBEN, DS, ECS, R/W, IPEND OCS, RMC, SIZ0–SIZ1, FC0–FC2 CBREQ, CIOUT, STATUS, REFILL	VOH	2.4	_	V
Output Low Voltage IOL = 3.2 mA IOL = 5.3 mA IOL = 2.0 mA IOL = 10.7 mA	A0–A31, FC0–FC2, SIZ0–SIZ1, BG, D0–D31 CBREQ, AS, DS, R/W, RMC, DBEN, IPEND STATUS, REFILL, CIOUT, ECS, OCS HALT,RESET	VoL	_ _ _ _	0.5 0.5 0.5 0.5	V
Power Dissipation (T _A =0C)		PD	_	2.6	W
Capacitance (see Note) Vin = 0 V, T _A =25C, f=1 MHz		C _{in}	_	20	pF
Load Capacitance	ECS, OCS CIOUT, STATUS, REFILL All Other	CL	_	50 70 130	pF

NOTE: Capacitance is periodically sampled rather than 100% tested.

AC ELECTRICAL SPECIFICATIONS — CLOCK INPUT (see Figure 10)

Num.	Characteristic	25MHz		40 MHz		Unit
		Min	Max	Min	Max	
	Frequency of Operation	12.5	25	25	40	MHz
1	Cycle Time Clock	40	80	25	40	ns
2,3	Clock Pulse Width Measured from 1.5 V to 1.5 V	19	61	11.5	29	ns
4,5	Clock Rise and Fall Times	_	4	_	2	ns



NOTE: Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range so that the rise or fall will be linear between 0.8 V and 2.0 V.

Figure 10. Clock Input Timing Diagram

AC ELECTRICAL SPECIFICATIONS -- READ AND WRITE CYCLES

(V_{CC}=5.0Vdc ± 5%; GND=0 Vdc; temperature in defined ranges; see Figures 11–16)

Num.	Characterstics	25MHz		40	MHz	Unit
		Min	Max	Min	Max	
6	Clock High to Function Code, Size, RMC, IPEND, CIOUT, Address Valid	0	20	0	14	ns
6A	Clock High to ECS, OCS Asserted	0	15	0	10	ns
6B	Function Code, Size, RMC, IPEND, CIOUT, Address Valid to Negating Edge of ECS	3		3		ns
7	Clock High to Function Code Size, RMC, CIOUT, Address Data High Impedance	0	40	0	25	ns
8	Clock High to Function Code Size, RMC, IPEND, CIOUT, Address Invalid	0	_	0	_	ns
9	Clock Low to AS, DS Asserted, CBREQ Valid	3	18	2	10	ns
9A ¹	AS to DS Assertion Skew (Read)	-10	10	-6	6	ns
9B ¹⁴	AS Asserted to DS Asserted (Write)	27	_	16	_	ns
10	ECS Width Asserted	10		5	_	ns
10A	OCS Width Asserted	10		5		ns
10B ⁷	ECS, OCS Width Negated	5	_	5	_	ns
11	Function Code, Size, RMC, CIOUT, Address Valid to AS Asserted (and DS Asserted, Read)	7		5		ns
12	Clock Low to AS, DS, CBREQ Negated	0	18	0	10	ns
12A	Clock Low to ECS/OCS Negated	0	18	0	12	ns
13	AS, DS Negated to Function Code, Size, RMC CIOUT, Address Invalid	7		3	_	ns
14	AS (and DS Read) Width Asserted (Asynchronous Cycle)	70	_	30	_	ns
14A ¹¹	DS Width Asserted (Write)	30	_	18	_	ns
14B	AS (and DS, Read) Width Asserted (Synchronous Cycle)	30	_	18	_	ns
15	AS, DS Width Negated	30	_	18	_	ns

AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES (Continued)

Num.	Characterstics	25MHz		40 MHz		Unit
		Min	Max	Min	Max	
15A ⁸	DS Negated to AS Asserted	25	_	16	_	ns
16	Clock High to AS, DS, R/W, DBEN, CBREQ High Impedance	_	40	_	25	ns
17	AS, DS Negated to R/W Invalid	7	_	3	_	ns
18	Clock High to R/W High	0	20	0	14	ns
20	Clock High to R/W Low	0	20	0	14	ns
21	R/W High to AS Asserted	7	_	5	_	ns
22	R/W Low to DS Asserted (Write)	47	_	24	_	ns
23	Clock High to Data-Out Valid	_	20	_	14	ns
24	Data-Out Valid to Negating Edge of AS	5	_	3	_	ns
25 ¹¹	AS, DS Negated to Data-Out Invalid	7	_	3	_	ns
25A ^{9,11}	DS Negated to DBEN Negated (Write)	7	_	3	_	ns
26 ¹¹	Data-Out Valid to DS Asserted (Write)	7	_	3	_	ns
27	Data-In Valid to Clock Low (Setup)	2	_	1	_	ns
27A	Late BERR/HALT Asserted to Clock Low (Setup)	5	_	3	_	ns
28 ¹²	AS, DS Negated to DSACKx, BERR, HALT, AVEC Negated (Asynchronous Hold)	0	40	0	20	ns
28A ¹²	Clock Low to DSACKx, BERR, HALT, AVEC Negated (Synchronous Hold)	8	70	6	40	ns
29 ¹²	AS, DS Negated to Data-In Invalid (Asynchronous Hold)	0	_	0	_	ns
29A ¹²	AS, DS Negated to Data-In High Impedance	_	40	_	25	ns
30 ¹²	Clock Low to Data-In Invalid (Synchronous Hold)	8	_	6	_	ns
30A ¹²	Clock Low to Data-In High Impedance (Read followed by Write)		60	_	30	ns
31 ²	DSACKx Asserted to Data-In Valid (Asynchronous Data Setup)	_	28	_	14	ns
31A ³	DSACKx Asserted to DSACKx Valid (Skew)	_	7	_	3	ns
32	RESET Input Transition Time	_	1.5	_	1.5	Clks
33	Clock Low to BG Asserted	0	20	0	14	ns
34	Clock Low to BG Negated	0	20	0	14	Clks
35	BR Asserted to BG Asserted (RMC Not Asserted)	1.5	3.5	1.5	3.5	Clks
37	BGACK Asserted to BG Negated	1.5	3.5	1.5	3.5	Clks
37A ⁶	BGACK Asserted to BR Negated	0	1.5	0	1.5	ns
39	BG Width Negated	60	_	30	_	ns
39A	BG Width Asserted	60	_	30	_	ns
40	Clock High to DBEN Asserted (Read)	0	20	0	16	ns
41	Clock Low to DBEN Negated (Read)	0	20	0	16	ns
42	Clock Low to DBEN Asserted (Write)	0	20	0	16	ns
43	Clock High to DBEN Negated (Write)	0	20	0	16	ns

AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES (Concluded)

Num.	Characterstics		25 MHz		40 MHz		Unit
			Min	Max	Min	Max	
44	R/W Low to DBEN Asserted (Write)		7	_	5	_	ns
45 ⁵	DBEN Width Asserted	Asynchronous Read Asynchronous Write	40 80	_	22 45		ns
45A ⁹	DBEN Width Asserted	Synchronous Read Synchronous Write	5 40	_ _	5 22	_	ns
46	R/W Width Asserted (Asynchronous Write or Read)		100	_	50	_	ns
46A	R/W Width Asserted (Synchronous Write or Read)		60	_	30	_	ns
47A	Asynchronous Input Setup Time to Clock Low		2	_	2	_	ns
47B	Asynchronous Input Hold Time from Clock Low		8	_	6	_	ns
48 ⁴	DSACKx Asserted to BERR, HALT Asserted		_	25	_	14	ns
53	Data-Out Hold from Clock High		3	_	2	_	ns
55	R/W Asserted to Data Bus Impedance Change		20	_	11	_	ns
56	RESET Pulse Width (Reset Instruction)		512	_	512	_	Clks
57	BERR Negated to HALT Negated (Rerun)		0	_	0	_	ns
58 ¹⁰	BGACK Negated to Bus Driven		1	_	1	_	Clks
59 ¹⁰	BG Negated to Bus Driven		1	_	1	_	Clks
60 ¹³	Synchronous Input Valid to Clock High (Setup Time)		2	_	2		ns
61 ¹³	Clock High to Synchronous Input Invalid (Hold Time)		8		6	_	ns
62	Clock Low to STATUS, REFILL Asserte	ed	0	20	0	15	ns
63	Clock Low to STATUS, REFILL Negated		0	20	0	15	ns

NOTES:

- 1. This number can be reduced to 5 ns if strobes have equal loads.
- 2. If the asynchronous setup time (#47A) requirements are satisfied, the DSACKx low to data setup time (#31) and DSACKx low to BERR low setup time (#48) can be ignored. The data must only satisfy the data-in clock low setup time (#27) for the following clock cycle and BERR must only satisfy the late BERR low to clock low setup time (#27A) for the following clock cycle.
- 3. This parameter specifies the maximum allowable skew between DSACK0 to DSACK1 asserted or DSACK1 to DSACK0 asserted; specification #47A must be met by DSACK0 or DSACK1.
- 4. This specification applies to the first (DSACK0 or DSACK1) DSACKx signal asserted. In the absence of DSACKx, BERR is an asynchronous input using the asynchronous input setup time (#47A).
- 5. DBEN may stay asserted on consecutive write cycles.
- 6. The minimum values must be met to guarantee proper operation. If this maximum value is exceeded, BG may be reasserted.
- 7. This specification indicates the minimum high time for ECS and OCS in the event of an internal cache hit followed immediately by another cache hit, a cache miss, or an operand cycle.
- 8. This specification guarantees operation with the MC68881/MC68882, which specifies a minimum time for DS negated to AS asserted (specification #13A in the *MC68881/MC68882 User's Manual*). Without this specification, incorrect interpretation of specifications #9A and #15 would indicate that the MC68EC030 does not meet the MC68881/MC68882 requirements.
- 9. This specification allows a system designer to guarantee data hold times on the output side of data buffers that have output enable signals generated with DBEN. The timing on DBEN precludes its use for synchronous READ cycles with no wait states.
- 10. These specifications allow system designers to guarantee that an alternate bus master has stopped driving the bus when the MC68EC030 regains control of the bus after an arbitration sequence.
- 11. DS will not be asserted for synchronous write cycles with no wait states.
- 12. These hold times are specified with respect to strobes (asynchronous) and with respect to the clock (synchronous). The designer is free to use either time.
- 13. Synchronous inputs must meet specifications #60 and #61 with stable logic levels for *all* rising edges of the clock while AS is asserted. These values are specified relative to the high level of the rising clock edge. The values originally published were specified relative to the low level of the rising clock edge.
- 14. This specification allows system designers to qualify the CS signal of an MC68881/MC68882 with AS (allowing 7 ns for a gate delay) and still meet the CS to DS setup time requirement (spec 8B of the MC68881/MC68882 User's Manual).

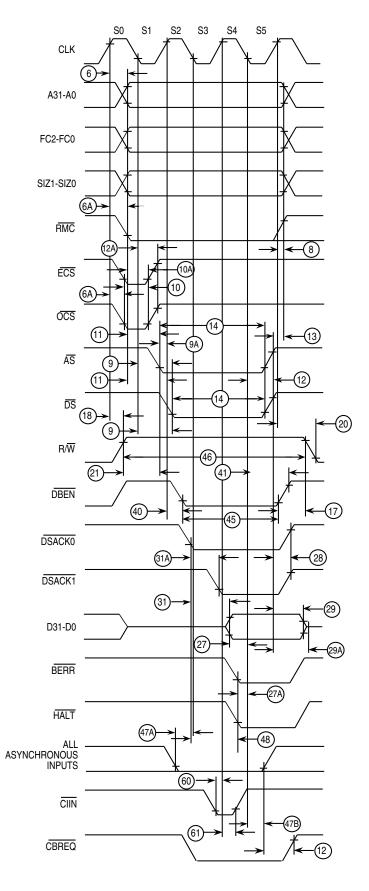


Figure 11. Asynchronous Read Cycle Timing Diagram

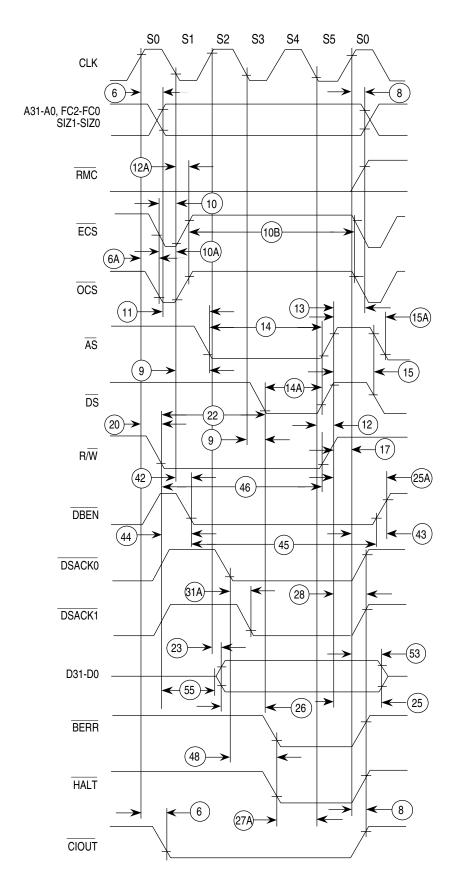


Figure 12. Asynchronous Write Cycle Timing Diagram

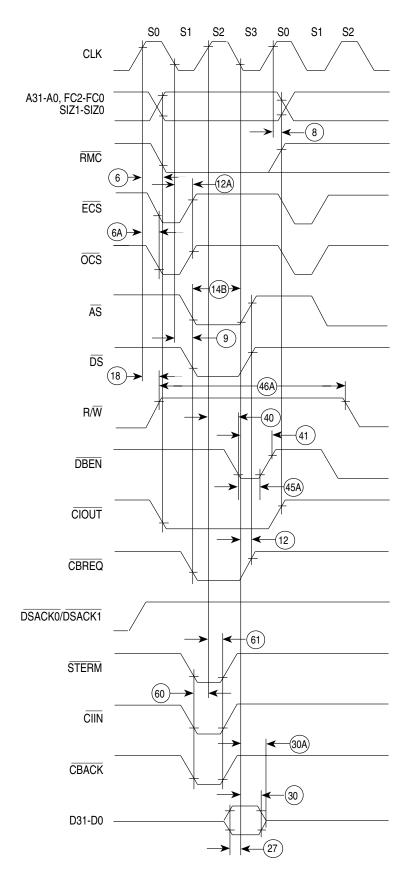


Figure 13. Synchronous Read Cycle Timing Diagram

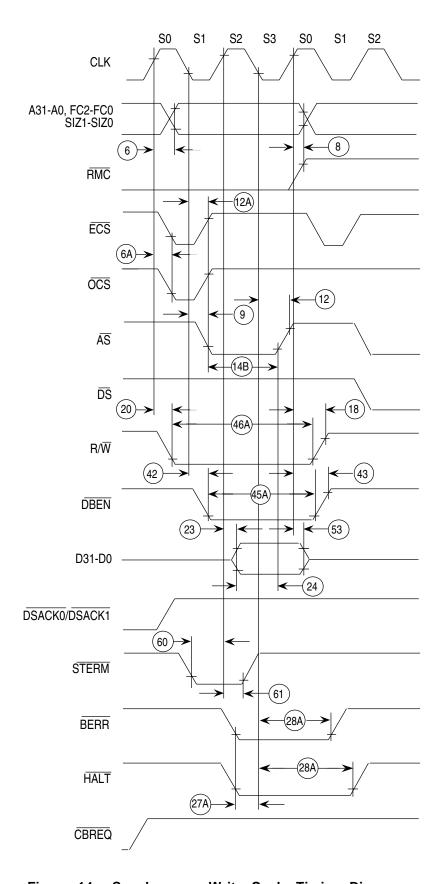
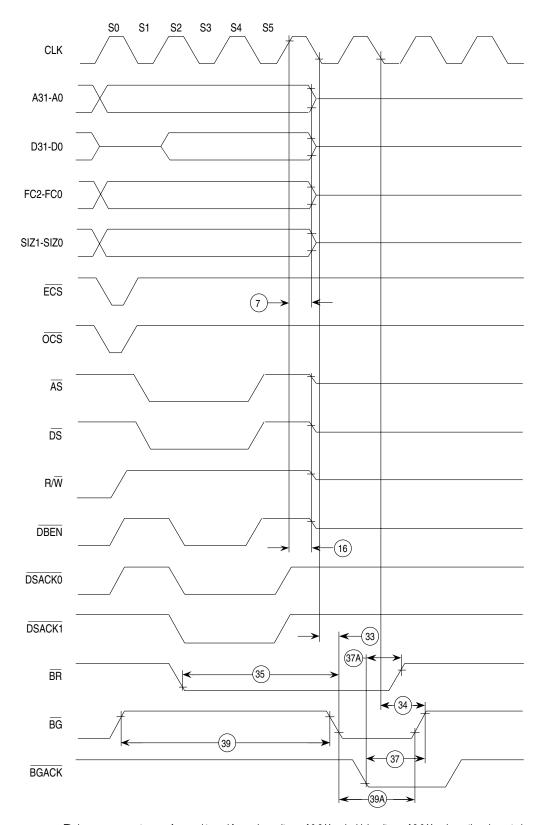


Figure 14. Synchronous Write Cycle Timing Diagram



NOTE: Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range so that the rise or fall will be linear between 0.8 V and 2.0 V.

Figure 15. Bus Arbitration Timing Diagram

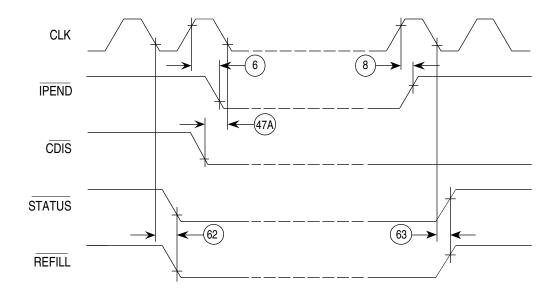
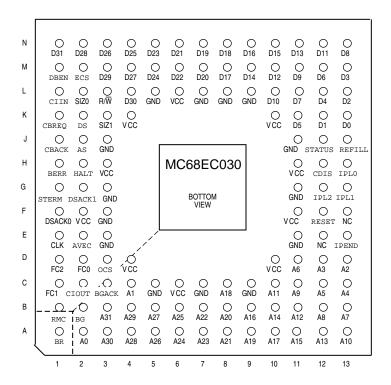


Figure 16. Other Signal Timings

MECHANICAL DATA

PIN ASSIGNMENTS — PIN GRID ARRAY (RC SUFFIX)



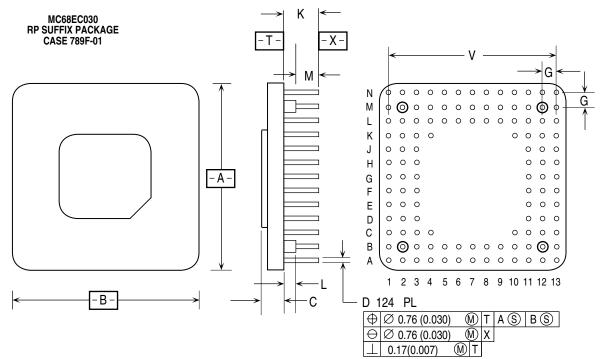
NOTE

The MC68030 has four additional guide pins not present on the MC68EC030. Therefore, an MC68EC030 fits in a socket designed for the MC68030, but the MC68030 does not necessary fit in a socket intended for the MC68EC030.

The Vcc and GND pins are separated into three groups to provide individual power supply connections for the address bus buffers, data bus buffers, and all other output buffers and internal logic

Pin Group	VCC	GND
Address Bus	C6, D10	C5, C7, C9, E11
Data Bus	L6, K10	J11, L9, L7, L5
ECS, SIZx, DS, AS, DBEN, CBREQ, R/W	K4	Ј3
FC0–FC2, RMS, OCS, CIOUT, BG	D4	E3
Internal Logic, RESET, STATUS, REFILL, Misc	H3, F2, F11, H11	L8, G3, F3, G11

PACKAGE DIMENSIONS



	MILLIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	34.04	35.05	1.340	1.380	
В	34.04	35.05	1.340	1.380	
С	2.92	3.18	0.115	0.135	
D	0.44	0.55	0.017	0.022	
G	2.54 BSC		0.100 BSC		
K	4.32	4.95	0.170	0.195	
L	1.02	1.52	0.040	0.060	
M	2.79	3.81	0.110	0.150	
٧	30.48	30.48 BSC 1.200 BSC			

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH
- 3. DIMENSION D INCLUDES LEAD FINISH.

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MC68030 : Enhanced 32-Bit Processor

The MC68030 provides a code-compatible upgrade path to the MC68020. It offers enhanced performance through additional cache, a memory management unit, and a bursting data bus. The MC68EC030 offers a lower cost embedded solution by removing the memory management unit.



Block Diagram

MC68030 Features

- On-Chip Memory Management Unit (MC68030)
- Internal Harvard Architecture

nit (

- 256 Byte Instruction and Data Caches
- Dynamic Bus Sizing
- Burst Memory Interface
- 18 MIPS @ 50MHz
- Available in 16, 20, 25, 33, 40, and 50 MHz
- MC68EC030 Available in 25 and 40 MHz

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- Related Links

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MC68030 Parametrics

Processor Speed (MHz)	Performance_1 (Max) (MIPS)	Cache-L1 Inst/Data (Bytes)	Bus Interface (Bits)	Memory	Availability
16, 20, 25, 33, 40, 50	18	256 Bytes	32-Bit, Dynamic	On-Chip MMU	Now

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MC68030 Documentation

ID	Name	Format	Size K	Rev#	Date Last Modified	Order Availability
CFPITCHPAK/D	68K ColdFire Product Portfolio	html	1	0	10/14/2002	

Data Sheets

ID Name Format Size K Rev # Date Last Modified Order Availability

MC68EC030TS Second-Generation 32-Bit Enhanced Embedded Controller pdf 169 1 10/22/1997 -

Packages & Pinouts

ID Name Format Size K Rev # Date Last Modified Order Availability

MC68030RC 68030 RC Package Pinout and Case Diagram pdf 541 - - - - - -

Product Change Notices

ID	Name	Format S	Size K I	Rev # Da	te Last Modified Order	Availability
PCN2560	MC68030 (RP Package Addendum) - PCN #2560	html	4	-	2/28/1997	-
PCN2921	MC68030 /68EC030 TQFP End-of-Life Announcement- PCN#2921	html	5	-	6/30/1997	-
PCN2999	Standardize Packing Quantity for 68030/68040 - PCN #2999	html	7	-	8/19/1997	-
PCN5325	PCN #5325 Citizen RP Package Discontinuance	html	7	-	12/22/1999	=
PCN5826	Laser Marking of MC68020RC/030RC Devices, PCN #5826	txt	4	-	8/22/2000	-
PCN6093	68020/030 RP Package Discontinuance, PCN #6093	txt	6	-	11/21/2000	-
PCNR00268	F91C Mask Set Introduction #R00268	html	6	-	8/22/1995	-
PCNR00272	Additional Passivatrion Machines for the 68030- PCN #MPU-PCN-95-R00272	html	7	-	4/04/1995	-
PCNR00274	E71M and E42K MC-Qualified Mask Sets - PCN# MPU-PCN-95-R00274	html	13	-	5/03/1995	-
PCNR0028	Die Attach Change for Ceramic Quad Flat Packages (CQFP)- PCN #R00281	html	8	-	8/15/1995	-
PCNR00282	Addendum to PCN# MPU-PCN-95-R00268 #R00282	html	4	-	8/22/1995	-
PCNR00283	Introduction of F91C (0.8 Micron 68030) in Plastic Packages - PCN# MPU-PCN-95-R00283	html	6	-	8/23/1995	-
PCNR00320	Moisture Sensitivity Level change for 144 TQFP Products - PCN# R00320	html	8	-	7/13/1996	-
PCNR0032	MC68030 Alternate Wafer Fab and Mask Set Introduction - PCN #R00321	html	22	-	8/05/1996	-

Quality Information

ID	Name	Format	Size K	Rev#	Date Last Modified	Order Availability
PRODRELQ	Product Reliability Information (2Q97-3Q98)	html	4	-	12/31/1998	-
REL4Q98QI	Product Reliability Information 4Q98	pdf	160	-	12/31/1998	-

Reference Manual

ID	Name	Format	Size K I	Rev # Da	ate Last Modified	Order Availability
M68000PRM	68000 Family Programmer's Reference Manual	pdf	2338	-	-	-
M68000PRMER	68K Programmer's Ref. Manual Errata	txt	0	-	-	-
MC68030UM-P1/D	MC68030 Enhanced Microprocessor User's Manual (Part 1 of 2)	pdf	855	3	1/01/1992	-
MC68030UM-P2/D	MC68030 User's Manual (Part 2 of 2)	pdf	781	1	1/01/1992	-
MC68030UM/D	MC68030 Enhanced 32-Bit Microprocessor User's Manual (Complete)	pdf	1441	3	1/01/1992	-
MC68EC030UM/AD	MC68EC030 32-Bit Embedded Controller User's Manual Addendum	pdf	72	2	4/17/1996	-

Reports or Presentations

ID	Name	Format	Size K Rev #	Date Last Modified	Order Availability
MC680X0OPTAPP	Optimizing 680X0 Applications	txt	12 -	-	-

Selector Guide

ID	Name	Format	Size K	Rev#	Date Last Modified	Order Availability
SG1001/D	32-Bit Embedded Processors	pdf	587	0	6/27/2002	

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Design Tools

Benchmark

ID	Name	Vendor ID	Forma	t Size K	Rev#	
68KDHRY1	Dhrystone 1.1 Benchmark C Source Code File	MOTOROLA	txt	8	-	
<u>68KDHRY2-P1</u>	Dhrystone 2.1 Benchmarking Part 1 (C Header File)	MOTOROLA	txt	17	-	
<u>68KDHRY2-P2</u>	Dhrystone 2.1 Benchmarking Part 1 (C Source)	MOTOROLA	txt	6	2.1	

68KDHRY2-P3	Dhrystone 2.1 Benchmarking Part 3 (C Source)	MOTOROLA	txt	5	-
M68KACKBM	Ackerman Benchmark With a Downloadable C Source Code F	ile MOTOROLA	txt	1	-
M68KFIBBM	Fibonacci Benchmark With Downloadable C Source Code File	MOTOROLA	txt	1	-
M68KSIEBM	Sieve Benchmark With Downloadable C Source Code File	MOTOROLA	txt	1	-
Converters					
ID PORTASM68K	Name MicroAPL Limited's ColdFire Assembler Converter FREE!	Vendor ID MICROAPL	Forma html	nt Size K	Rev # 1.2.7
Miscellaneous					
ID	Name	Vendor ID	Format	Size K	Rev#
<u>M68000AMPRT</u>	Amiga Port of Matthew Brandt's CC68K Compiler	MOTOROLA	html	0	-
M68000AS332	AS332.ARC-Freeware	MOTOROLA	arc	57	-
M68000ASMBLI	68K Assembler v 2.71	MOTOROLA	lzh	54	-
M68000ASS_SIM	68000 Assembler/Simulator for MS-DOS	MOTOROLA	zip	157	-
M68000BFP	S-Record to C-Struct or Binary File Program	MOTOROLA	txt	7	-
M68000CPLR	68K Compiler	MOTOROLA	html	0	-
M68000UNIX	68K Assembler-Berkeley UNIX	MOTOROLA	arc	68	-
M68000XASS	M680x0 cross assembler MS-DOS	MOTOROLA	zip	114	-
Software					
ID	Name	Vendor ID I	Format	Size K	Rev#
<u>M68000MTS</u>	Memory Test Software for 68K Memory Test Software for the M68000 Family	MOTOROLA	pdf	115	0

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Orderable Parts Information

PartNumber	Package Info	Life Cycle Description (code)	Remarks	Budgetary Price OTY 1000+ (\$US)	Order Availability
MC68EC030FE25C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	Embedded 030 (No MMU); Samples can be ordered on this device number	\$20.71	
MC68EC030FE40C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	Embedded 030 (No MMU); Samples can be ordered on this device number	\$28.71	
MC68EC030CFE25C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	Ext Temp, Embedded 030 (No MMU); Samples can be ordered on this device number	\$29.84	
MC68030FE16C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$31.15	
MC68030FE20C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$31.15	
MC68030FE25C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$39.27	

MC68030FE33C	132 CQUAD (Ceramic Quad)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$39.27	
MC68030RC16C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$41.71	
MC68030RC20C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$41.71	
MC68030RC25C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$47.41	
MC68030RC33C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$47.41	
MC68030RC40C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$52.67	
MC68030RC50C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	On-Chip Cache and MMU; Samples can be ordered on this device number	\$58.38	

MC68030CRC25C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	Ext Temp, On- Chip Cache and MMU; Samples can be ordered on this device number	\$62.64	
MC68030CRC33C	128 PGA (Pin Grid Array)	PRODUCT MATURITY/SATURATION(4)	Ext Temp, On- Chip Cache and MMU; Samples can be ordered on this device number	\$71.37	

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MC68030: Enhanced 32-Bit Processor

The MC68030 provides a code-compatible upgrade path to the MC68020. It offers enhanced performance through additional cache, a memory management unit, and a bursting data bus. The MC68EC030 offers a lower cost embedded solution by removing the memory management unit.

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- Available in 16, 20, 25, 33, 40, and 50 MHz
- MC68EC030 Available in 25 and 40 MHz

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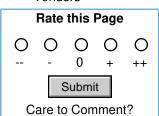
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- Training
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- Vendors



MC68030 Documentation

Documentation

Brochure

ID	Name	Vendor ID	Format	Size K	Rev#	Date Last Modified	Order Availability
CFPITCHPAK	68K ColdFire Product Portfolio	MOTOROLA	html	1	0	10/14/2002	ORDER 😾

Data Sheets

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
MC68EC030TS	MC68EC030TS Second-Generation 32-Bit Enhanced Embedded Controller	MOTOROLA	pdf	169	1	10/22/1997	-

Packaging Information

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
MC68030RC	68030 RC Package Pinout and Case Diagram	MOTOROLA	pdf	541	-	-	-

Product Change Notices

ID ID	Name	Vendor ID	Format	Size K	Rev #		Order Availability
PCN2560	MC68030 (RP Package Addendum) - PCN #2560	MOTOROLA	html	4	-	2/28/1997	-
PCN2921	MC68030 /68EC030 TQFP End-of-Life Announcement-PCN#2921	MOTOROLA	html	5	-	6/30/1997	-
PCN2999	Standardize Packing Quantity for 68030/68040 - PCN #2999	MOTOROLA	html	7	-	8/19/1997	-
PCN5325	PCN #5325 Citizen RP Package Discontinuance	MOTOROLA	html	7	-	12/22/1999	-
PCN5826	Laser Marking of MC68020RC/030RC Devices, PCN #5826	MOTOROLA	txt	4	-	8/22/2000	-
PCN6093	68020/030 RP Package Discontinuance, PCN #6093	MOTOROLA	txt	6	-	11/21/2000	-
PCNR00268	F91C Mask Set Introduction #R00268	MOTOROLA	html	6	-	8/22/1995	-
PCNR00272	Additional Passivatrion Machines for the 68030- PCN #MPU-PCN-95-R00272	MOTOROLA	html	7	-	4/04/1995	-
PCNR00274	E71M and E42K MC-Qualified Mask Sets - PCN# MPU-PCN-95-R00274	MOTOROLA	html	13	-	5/03/1995	-
PCNR00281	Die Attach Change for Ceramic Quad Flat Packages (CQFP)- PCN #R00281	MOTOROLA	html	8	-	8/15/1995	-
PCNR00282	Addendum to PCN# MPU-PCN-95-R00268 #R00282	MOTOROLA	html	4	-	8/22/1995	-
PCNR00283	Introduction of F91C (0.8 Micron 68030) in Plastic Packages - PCN# MPU-PCN-95-R00283	MOTOROLA	html	6	-	8/23/1995	-
PCNR00320	Moisture Sensitivity Level change for 144 TQFP Products - PCN# R00320	MOTOROLA	html	8	-	7/13/1996	-
PCNR00321	MC68030 Alternate Wafer Fab and Mask Set Introduction - PCN #R00321	MOTOROLA	html	22	-	8/05/1996	-

Reference Manual

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
M68000PRM	68000 Family Programmer's Reference Manual	MOTOROLA	pdf	2338	-	-	-
M68000PRMER	68K Programmer's Ref. Manual Errata	MOTOROLA	txt	0	-	-	-
MC68030UM-P1/D	MC68030 Enhanced Microprocessor User's Manual (Part 1 of 2)	MOTOROLA	pdf	855	3	1/01/1992	-
MC68030UM-P2/D	MC68030 User's Manual (Part 2 of 2)	MOTOROLA	pdf	781	1	1/01/1992	-
MC68030UM/D	MC68030 Enhanced 32-Bit Microprocessor User's Manual (Complete)	MOTOROLA	pdf	1441	3	1/01/1992	-
MC68EC030UM/AD	MC68EC030 32-Bit Embedded Controller User's Manual Addendum	MOTOROLA	pdf	72	2	4/17/1996	-

Reliability and Quality Information

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
<u>PRODRELQI</u>	Product Reliability Information (2Q97-3Q98)	MOTOROLA	html	4	-	12/31/1998	-
REL4Q98QI	Product Reliability Information 4Q98	MOTOROLA	pdf	160	-	12/31/1998	-

Reports or Presentations

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
MC680X0OPTAPP	Optimizing 680X0 Applications	MOTOROLA	txt	12	-	-	<u>-</u>

Roadmap

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
COLDFIRERD	ColdFire Performance Roadmap	MOTOROLA	pdf	79	0	10/23/2002	-

Selector Guide

ID	Name	Vendor ID	Format	Size K	Rev #	Date Last Modified	Order Availability
<u>SG1001</u>	32-Bit Embedded Processors - Quarter 4, 2003	MOTOROLA	pdf	877	1	11/07/2003	ORDER 😾

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MC68030 Tools

Hardware Tools

Emulators/Probes/Wigglers

ID	Name	Vendor ID	Format	Size K	Rev #	Order Availability
HMI-200-68030	HMI-200-68030 In-Circuit Emulator	AVOCET	-	-	-	-

Software

Application Software Code Examples

ID .	Name	Vendor ID	Format	Size K		Order Availability
68KDHRY1	Dhrystone 1.1 Benchmark C Source Code File	MOTOROLA	txt	8	-	-
68KDHRY2-P1	Dhrystone 2.1 Benchmarking Part 1 (C Header File)	MOTOROLA	txt	17	-	-
68KDHRY2-P2	Dhrystone 2.1 Benchmarking Part 1 (C Source)	MOTOROLA	txt	6	2.1	-
68KDHRY2-P3	Dhrystone 2.1 Benchmarking Part 3 (C Source)	MOTOROLA	txt	5	-	+
M68000MTS	Memory Test Software for the M68000 Family	MOTOROLA	pdf	115	-	-
M68KACKBM	Ackerman Benchmark With a Downloadable C Source Code File	MOTOROLA	txt	1	-	-
M68KFIBBM	Fibonacci Benchmark With Downloadable C Source Code File	MOTOROLA	txt	1	-	-
M68KSIEBM	Sieve Benchmark With Downloadable C Source Code File	MOTOROLA	txt	1	-	-

Operating Systems

ID	Name	Vendor ID	Format	Size K	Rev #	Order Availability
CMX-RTX	CMX-RTX	CMX	-	-	-	-

Protocol Stacks

ID	Name	Vendor ID	Format	Size K	Rev #	Order Availability
CMX TCP/IP	CMX TCP/IP	<u>CMX</u>	-	-	-	-

Software Tools Assemblers

ID	Name	Vendor ID	Format	Size K	Rev#	Order Availability
M68000AS332	AS332.ARC-Freeware	MOTOROLA	arc	57	-	-
M68000ASMBLR	68K Assembler v 2.71	MOTOROLA	lzh	54	-	-
M68000ASS_SIM	68000 Assembler/Simulator for MS-DOS	MOTOROLA	zip	157	-	-
M68000UNIX	68K Assembler-Berkeley UNIX	MOTOROLA	arc	68	-	-
M68000XASS	M680x0 cross assembler MS-DOS	MOTOROLA	zip	114	-	-
ADX-68K	ADX-68K Macro Assembler-Linker and IDE	AVOCET	-	-	-	-

Code Translation

ID	Name	Vendor ID	Format	Size K	Rev #	Order Availability
M68000BFP	S-Record to C-Struct or Binary File Program	MOTOROLA	txt	7	-	-
PORTASM68K	MicroAPL Limited's ColdFire Assembler Converter FREE! Assembly-language source-code translation tool, converts M680x0 and CPU32 assembly- language code to optimized ColdFire assembly- language. Compatible with the main ColdFire toolsets.	MICROAPL	html	1	1.2.7	-

Compilers

ID	Name	Vendor ID	Format	Size K	Rev#	Order Availability
M68000AMPRT	Amiga Port of Matthew Brandt's CC68K Compiler	MOTOROLA	html	0	-	-
M68000CPLR	68K Compiler	MOTOROLA	html	0	-	-
DIAB	Diab C/C++ Compiler	WINDRIV	-	-	-	-

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					Orderable P	arts Information
PartNumber	Package Info	Tape and Reel	Life Cycle Description (code)	Budgetary Price QTY 1000+ (\$US)	Additional Info	Order Availability
MC68030CRC25C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$62.64	<u>more</u>	BUY 📜
MC68030CRC33C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$71.37	more	BUY 📜
MC68030FE16C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$31.15	<u>more</u>	BUY 📜
MC68030FE20C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$31.15	<u>more</u>	BUY 📜
MC68030FE25C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$39.27	<u>more</u>	BUY 📜
MC68030FE33C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$39.27	more	BUY 📜
MC68030RC16C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$41.71	more	BUY 📜
MC68030RC20C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$41.71	more	BUY 🛱

MC68030RC25C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$47.41	more	BUY 🦙
MC68030RC33C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$47.41	more	BUY 🦙
MC68030RC40C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$52.67	more	BUY 🙀
MC68030RC50C	PGA 128	No	PRODUCT MATURITY/SATURATION(4)	\$58.38	more	BUY 🙀
MC68EC030CFE25C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$29.84	<u>more</u>	BUY 🦙
MC68EC030FE25C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$20.71	more	BUY 🙀
MC68EC030FE25CB1	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	-	more	-
MC68EC030FE40C	<u>CQUAD</u> <u>132</u>	No	PRODUCT MATURITY/SATURATION(4)	\$28.71	<u>more</u>	BUY 🙀

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